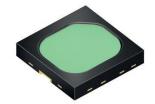
SFH 4735

OSLON® Black Flat

OSLON Black Flat (IR broad band emitter) - 120°





Applications

- Electronic Equipment

Features:

- Package: SMD epoxy package
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)
- SMD epoxy package
- ThinGaN (UX:3)
- Wide viewing angle of 120°
- Improved Corrosion Robustness
- Low thermal resistance (Max. 9 K/W)

Ordering Information

Туре	Total radiant flux $^{1)}$ typ. $I_F = 350$ mA; $t_p = 20$ ms Φ_e	Ordering Code	
SFH 4735	200 mW	Q65111A9885	



Maximum Ratings

T_A = 25 °C

Parameter	Symbol		Values
Operating temperature	T _{op}	min.	-40 °C
		max.	85 °C
Storage temperature	T _{stg}	min.	-40 °C
	3.9	max.	85 °C
Junction temperature	T_{j}	max.	125 °C
Forward current	I _F	max.	500 mA
Surge current	I _{FSM}	max.	1 A
$t_{p} \le 1 \text{ ms; D} = 0$			
Reverse current ²⁾	I _R	max.	200 mA
Power consumption	P _{tot}	max.	1900 W
ESD withstand voltage	V _{ESD}	max.	2 kV
acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)			

For the forward current and power consumption please see "maximum permissible forward current" diagram



Characteristics

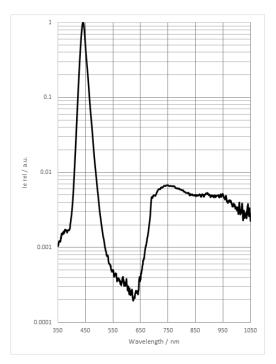
 $I_{_{\rm F}}$ = 350 mA; $t_{_{
m D}}$ = 20 ms; $T_{_{
m A}}$ = 25 °C

Symbol		Values
φ	typ.	60 °
V_{F}	typ. max.	2.95 V 3.5 V
V_{F}	typ. max.	3 V 3.8 V
V_R	max.	1.2 V
V _{R ESD}	min.	45 V
Фе	typ.	184 mW
Фе	typ.	16 mW
l _e	typ.	59 mW/sr
l _e	typ.	5 mW/sr
Фе	typ.	60 μW/nm
Фе	typ.	45 μW/nm
Фе	typ.	45 μW/nm
R_{thJS}	max.	9.0 K / W
	$\begin{array}{c} \phi \\ V_F \\ V_F \\ V_R \\ \end{array}$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$



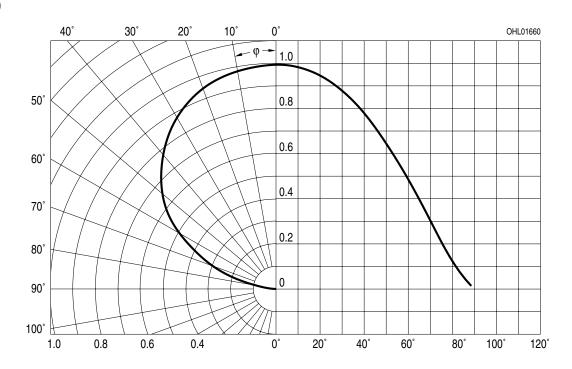
Relative Spectral Emission 5), 6)

 $I_{rel} = f(\lambda); I_F = 350 \text{ mA}; t_p = 10 \text{ ms}$



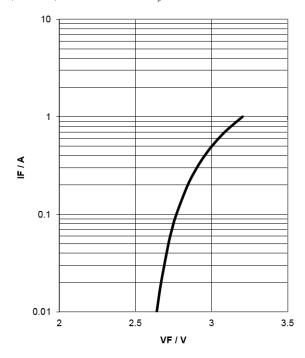
Radiation Characteristics 5), 6)

 $I_{rel} = f(\phi)$



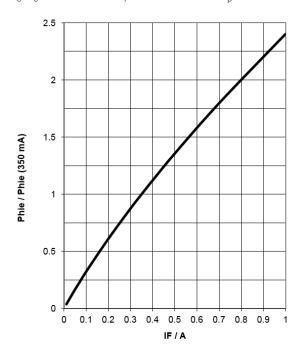
Forward current 5), 6)

 $I_F = f(V_F)$; single pulse; $t_D = 100 \mu s$



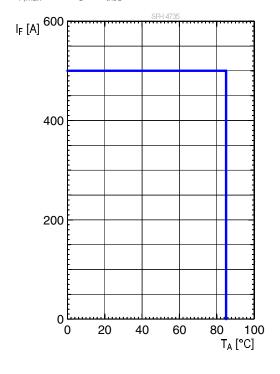
Relative Total Radiant Flux 5), 6)

 Φ_e/Φ_e (350mA) = f (I_F); single pulse; t_p = 100 µs



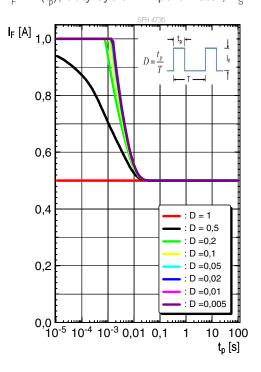
Max. Permissible Forward Current

$$I_{F,max} = f(T_S); R_{thJS} = 9.0 K/W$$

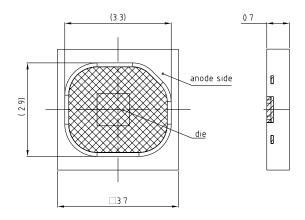


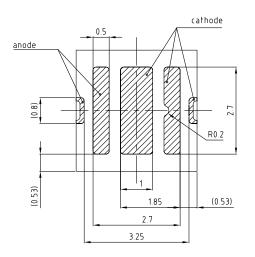
Permissible Pulse Handling Capability

 $I_{E} = f(t_{D})$; duty cycle D = parameter; $T_{S} = 85^{\circ}$ C



Dimensional Drawing 7)





general tolerance ± 0.1 lead finish Au

C67062-A0189-A103

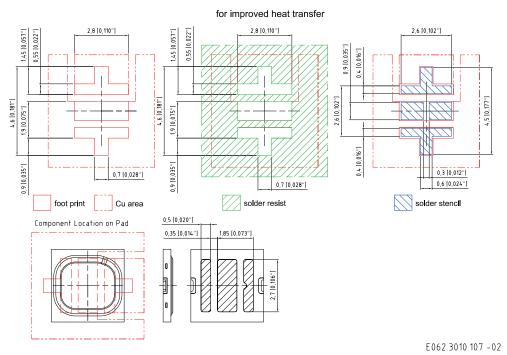
Approximate Weight: 230.0 mg

Package marking: Anode

ESD advice: LED is protected by ESD device which is connected in parallel to LED-Chip.

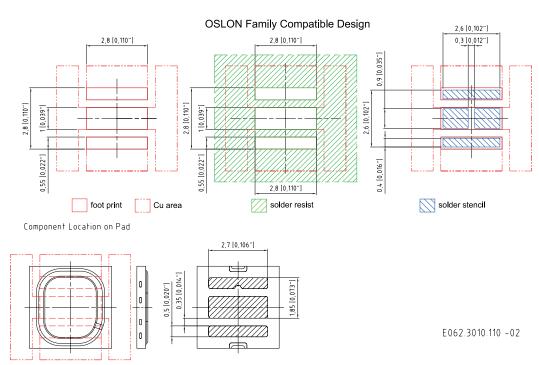


Recommended Solder Pad 7)



For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere.

Recommended Solder Pad 7)

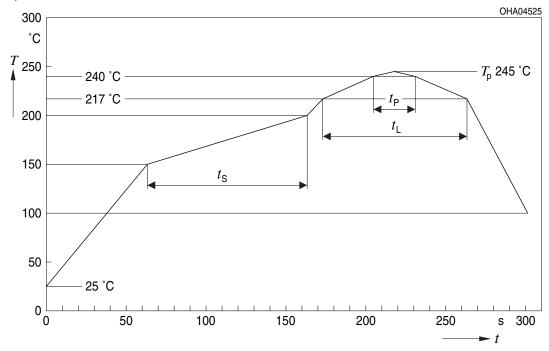


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere.



Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

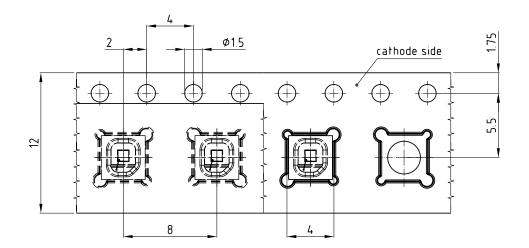


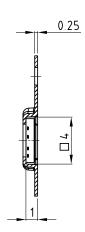
Profile Feature	Symbol	Pb	Pb-Free (SnAgCu) Assembly		
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t _s	60	100	120	S
Ramp-up rate to peak*) $T_{\rm Smax}$ to $T_{\rm P}$			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	$t_{\scriptscriptstyle \perp}$		80	100	S
Peak temperature	T _P		245	260	°C
Time within 5 °C of the specified peak temperature T _P - 5 K	t _P	10	20	30	S
Ramp-down rate* T _P to 100 °C			3	6	K/s
Time 25 °C to T _P				480	S

All temperatures refer to the center of the package, measured on the top of the component * slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range



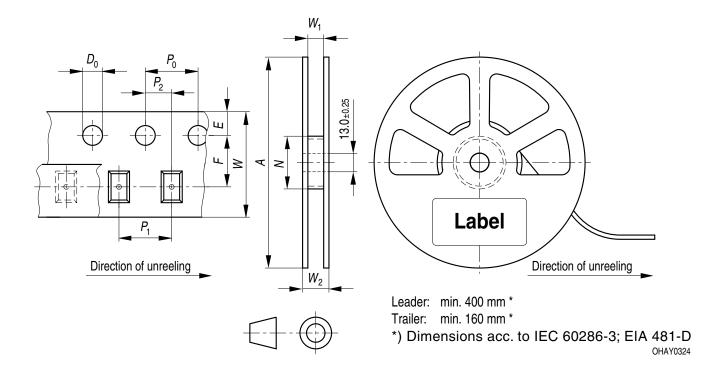
Taping 7)





C67062-A0030-B11-06

Tape and Reel 8)



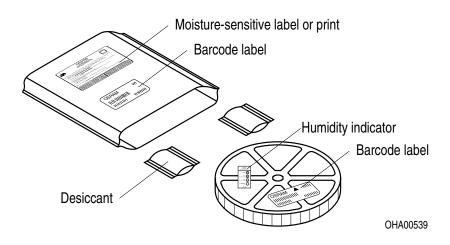


Reel dimensions [mm]						
Α	W	N_{\min}	W_1	$W_{2\mathrm{max}}$	Pieces per PU	
180 mm	12 + 0.3 / - 0.1	60	12.4 + 2	18.4	2000	

Barcode-Product-Label (BPL)

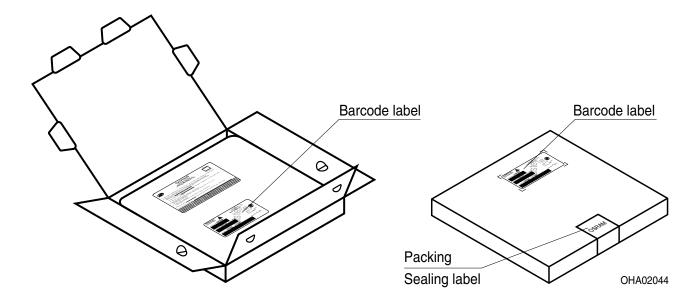


Dry Packing Process and Materials 7)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Transportation Packing and Materials 7)





Dimensions of transportation box in mm

Width	Length	Height
195 ± 5 mm	195 ± 5 mm	30 ± 5 mm



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the LED specified in this data sheet fall into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

For further application related informations please visit www.osram-os.com/appnotes



Disclaimer

Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version in the OSRAM OS Webside.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office.

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

In case Buyer – or Customer supplied by Buyer– considers using OSRAM OS components in product safety devices/applications or medical devices/applications, Buyer and/or Customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and Buyer and /or Customer will analyze and coordinate the customer-specific request between OSRAM OS and Buyer and/or Customer.



Glossary

- Total radiant flux: Measured with integrating sphere.
- ²⁾ **Reverse Operation**: Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- Radiant intensity: Measured at a solid angle of Ω = 0.01 sr
- Thermal resistance: junction soldering point, of the device only, mounted on an ideal heatsink (e.g. metal block)
- Typical Values: Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Testing temperature: $T_{\Delta} = 25^{\circ}C$
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- ⁸⁾ **Tape and Reel**: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



Published by OSRAM Opto Semiconductors GmbH EU RoHS and China RoHS compliant product Leibnizstraße 4, D-93055 Regensburg www.osram-os.com © All Rights Reserved.

此产品符合欧盟 RoHS 指令的要求; 按照中国的相关法规和标准,不含有毒有害物质或元素。

